SK50GAL065



IGBT Module

SK50GAL065 SK50GAR065

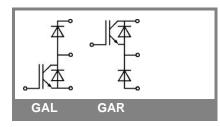
Preliminary Data

Features

- Compact design
- · One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- N-channel homogeneous silicon structure (NPT-Non-Punch-Through IGBT)
- Low tail current with low temperature dependence
- · Low treshold voltage

Typical Applications*

- Switching (not for linear use)
- Inverter
- Switched mode power supplies
- UPS



Absolut	te Maximum Ratings	T_s = 25 °C, unless otherwise s	pecified	
Symbol	Conditions		Values	Units
IGBT	•			
V_{CES}	T _j = 25 °C T _i = 125 °C		600	V
I _C	T _j = 125 °C	T _s = 25 °C	54	Α
		T _s = 80 °C	40	Α
I _{CRM}	I _{CRM} = 2 x I _{Cnom}		60	Α
V_{GES}			± 20	V
t _{psc}	V_{CC} = 300 V; $V_{GE} \le$ 20 V; V_{CES} < 600 V	T _j = 125 °C	10	μs
Inverse	Diode			
I _F	T _j = 150 °C	$T_s = 25 ^{\circ}C$	57	Α
		T _s = 80 °C	38	Α
I _{FRM}	I _{FRM} = 2 x I _{Fnom}		100	Α
I _{FSM}	t _p = 10 ms; half sine wave	T _j = 150 °C	440	Α
Freewh	eeling Diode			
I _F	T _j = 150 °C	T_s = 25 °C	57	Α
		T_s = 80 °C	38	Α
I _{FRM}			100	Α
I _{FSM}	t _p = 10 ms; half sine wave	T _j = 150 °C	440	Α
Module				
$I_{t(RMS)}$				Α
T _{vj}			-40 + 150	°C
T _{stg}			-40 + 125	°C
V _{isol}	AC, 1 min.		2500	V

Characteristics $T_s =$			25 °C, unless otherwise specified				
Symbol	Conditions		min.	typ.	max.	Units	
IGBT							
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_C = 1.4 \text{ mA}$		3	4	5	V	
I _{CES}	$V_{GE} = 0 V, V_{CE} = V_{CES}$	T _j = 25 °C			0,0044	mA	
I _{GES}	V _{CE} = 0 V, V _{GE} = 20 V	T _j = 25 °C			240	nA	
V_{CE0}		T _j = 25 °C		1,1		V	
		T _j = 125 °C		1,1		V	
r _{CE}	V _{GE} = 15 V	T _j = 25°C		15		mΩ	
		T _j = 125°C		19		mΩ	
V _{CE(sat)}	I _{Cnom} = 60 A, V _{GE} = 15 V			2	2,5	V	
		$T_j = 125^{\circ}C_{chiplev.}$		2,2		V	
C _{ies}				3,2		nF	
C _{oes}	$V_{CE} = 25, V_{GE} = 0 V$	f = 1 MHz		0,3		nF	
C _{res}				0,18		nF	
t _{d(on)}				60	80	ns	
t _r	R_{Gon} = 16 Ω	V _{CC} = 300V		30	40	ns	
E _{on}		I _C = 40A		1,1	1,4	mJ	
t _{d(off)}	$R_{Goff} = 16 \Omega$	T _j = 125 °C		220	280	ns	
t _f		V _{GE} =±15V		20	26	ns	
E _{off}				0,7	0,9	mJ	
$R_{th(j-s)}$	per IGBT				0,85	K/W	

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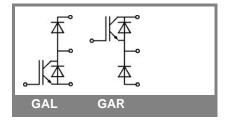
Typical Applications*

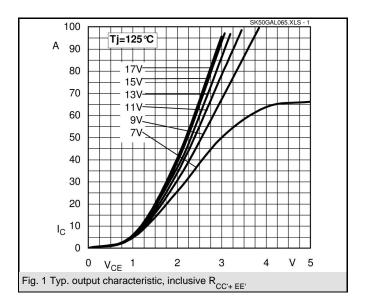
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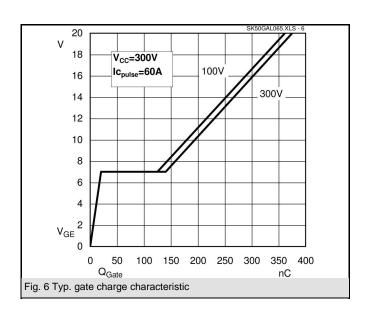
Characteristics								
Symbol	Conditions		min.	typ.	max.	Units		
Inverse Diode								
$V_F = V_{EC}$	$I_{Fnom} = 30 \text{ A}; V_{GE} = 0 \text{ V}$			1,3	1,5	V		
		T _j = 150 °C _{chiplev.}		1,2	1,45	V		
V_{F0}		T _j = 25 °C				V		
		T _j = 125 °C		0,85	0,9	V		
r _F		T _j = 25 °C				mΩ		
		T _j = 125 °C		9	16	mΩ		
I _{RRM}	I _F = 30 A	T _j = 125 °C		22		Α		
Q_{rr}	di/dt = -500 A/µs			2,2		μC		
E _{rr}	V _{CC} = 300V			0,2		mJ		
$R_{th(j-s)D}$	per diode				1,2	K/W		
	Freewheeling Diode							
$V_F = V_{EC}$	$I_{Fnom} = 30 \text{ A}; V_{GE} = 0 \text{ V}$	T _j = 25 °C _{chiplev.}		1,3	1,5	V		
		T _j = 125 °C _{chiplev.}		1,2	1,45	V		
V_{F0}		T _j = 125 °C		0,85	0,9	V		
r _F		T _j = 125 °C		9	16	V		
I _{RRM}	I _F = 30 A	T _j = 125 °C		22		Α		
Q_{rr}	di/dt = -500 A/µs			2,2		μC		
E _{rr}	V _R =300V			0,2		mJ		
R _{th(j-s)FD}	per diode				1,2	K/W		
M _s	to heat sink		•		2	Nm		
w				19		g		

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.







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